LAN Transformer Module

LAN-17J241P7D9

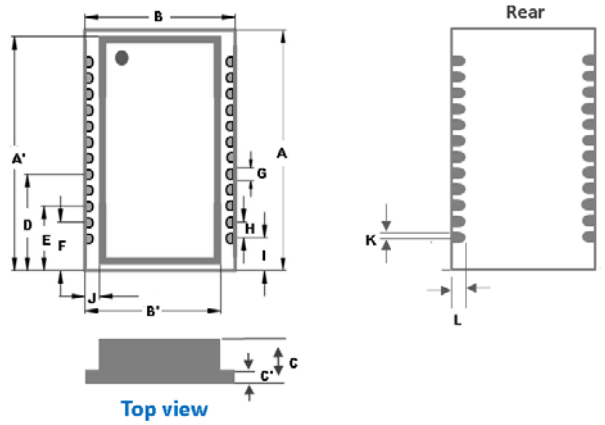
1. Features

1. Low profile, small footprint saves board space and height
2. Design for 10G ethernet application
3. Pin to Pin compatibility with LAN transformer
4. Operating temperature range: -40°C to +85°C
5. Storage temperature range: -40°C to +85°C
6. 100% Lead (Pb)-Free and RoHS compliant.

2. Applications

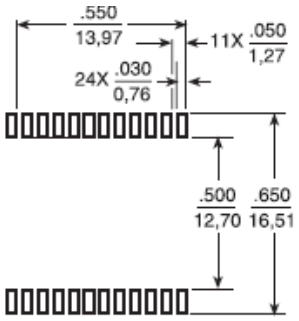
1. 10G Base-T, Single Port, Low profile Modules **(24 Pin)**
2. Notebook pc LAN Transformer Module
3. Hub switch, Ap router Multi-port LAN Transformer.

3. Dimensions



Size	A(mm)	A'(mm)	B(mm)	B'(mm)	C(mm)	C'(mm)
	17.53±0.25	17.03±0.25	14.6±0.25	13.92±0.25	4.5 max	1.0±0.25
	D(mm)	E(mm)	F(mm)	G(mm)	H(mm)	I(mm)
	6.86±0.25	4.32±0.25	3.05±0.25	0.4±0.15	1.27±0.15	1.78±0.25
	J(mm)	K(mm)	L(mm)			
	0.67±0.15	0.2±0.075	1.1±0.15			

Recommend PC Board Pattern



Units: mm (inch) Tolerance: XX.X0 +/-0.25 (0.010)
0.XX +/-0.05 (0.002)

4. Part Numbering

LAN	-	17	J	24	1	P7	D9
A		B	C	D	E	F	G

A: Series
B: Long
C: Application
D: Pin
E: Center tab
F: Pitch
G: Special

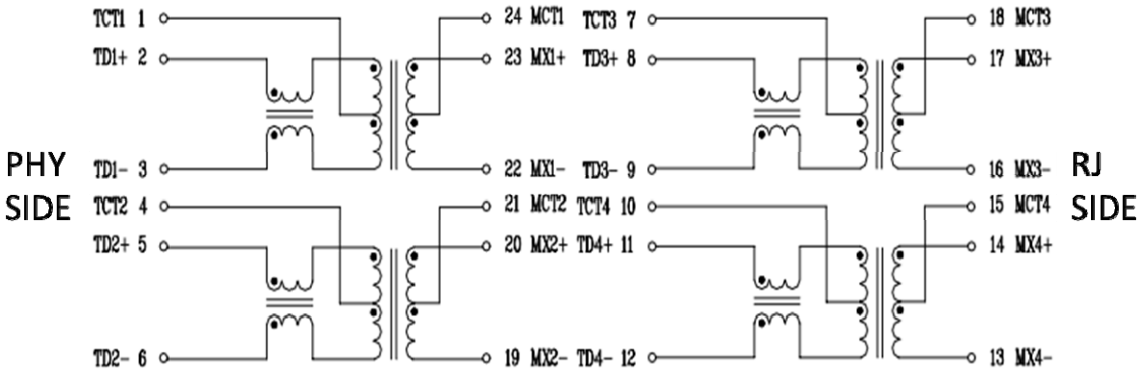
5. Specification

Part Number	OCL (uH Min) @100KHz/0.1V	Insertion Loss (dB Max)	Return Loss (dB min)		Cross talk (dB min)	DCMR(dB Min)	
		1~500MHz	1≦f≦40MHz	40≦f≦500MHz	1~500MHz	1~250MHz	250~500MHz
LAN-17J241P7D9	120	-3.0	-16	$-(16-10\log_{10}(f/40))$	-30	-22	-18

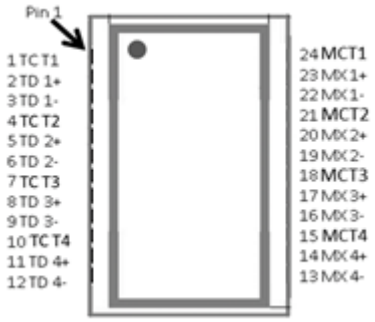
Note:

1. All test data referenced to 25℃ ambient
2. Hi-Pot resistance of 1500 VAC for 1 minute
3. Recommended: modules should be surface- mounted on the second time(last time) of customer's double-sided PCB to prevent shift of parts.

6. Schematic

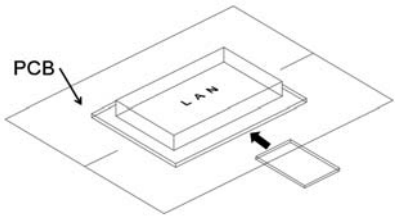


7. Pin Define



8. Reliability and Test Condition

<table>
<tr><th>Item</th><th>Performance</th><th>Test Condition</th></tr>
<tr><td>Insertion Loss</td><td rowspan="4">Refer to standard electrical characteristics list.</td><td rowspan="4">Agilent E5071C</td></tr>
<tr><td>Retuen Loss</td></tr>
<tr><td>Cross talk</td></tr>
<tr><td>DCMR</td></tr>
<tr><td>Operating Temperature</td><td>-40℃~+85℃(Including self - temperature rise)</td><td></td></tr>
<tr><td>Storage Temperature</td><td>-40℃~+85℃(Product without taping)</td><td></td></tr>
<tr><td>Life Test</td><td rowspan="2">Appearance：No damage.
Insertion Loss：within spec.
Return Loss：within spec.</td><td>Preconditioning: Run through Reflow for 3 times.
(IPC/JEDEC J-STD-020E Classification Reflow Profiles)
Temperature： 85±2℃
Duration：1000±12hrs
Measured at room temperature after placing for 24 hrs</td></tr>
<tr><td>Humidity Resistance Test</td><td>Preconditioning: Run through Reflow for 3 times.
(IPC/JEDEC J-STD-020E Classification Reflow Profiles)
Humidity：85±3% R.H,
Temperature：85℃±2℃
Duration：1000hrs Min.
Bead: with 100% rated current.
Inductance: with 10% rated current.
Measured at room temperature after placing for 24 hrs</td></tr>
<tr><td>Thermal shock Test</td><td rowspan="2">Appearance：No damage.
Insertion Loss：within spec.
Return Loss：within spec.</td><td>Preconditioning: Run through Reflow for 3 times.
(IPC/JEDEC J-STD-020E Classification Reflow Profiles)
Step1：-40±2℃ 30±5min
Step2：85±2℃ ≦0.5min
Step3：85±2℃ 30±5min
Number of cycles： 500
Measured at room temperature after placing for 24 hrs</td></tr>
<tr><td>Vibration Test</td><td>Preconditioning: Run through Reflow for 3 times.
(IPC/JEDEC J-STD-020E Classification Reflow Profiles)
Oscillation Frequency: 10Hz～2KHz～10Hz for 20 minutes
Equipment： Vibration checker
Total Amplitude:10g
Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations)</td></tr>
<tr><td>Solderability Test</td><td>More than 95% of bottom terminal electrode should be covered with solder.</td><td>a. Method B, 4 hrs @155°C dry heat @235°C±5°C
Test time:5 +0/-0.5 seconds.

b. Method D category 3. (steam aging 8hours ± 15 min)@ 260°C±5°C
Test time: 30 +0/-0.5 seconds.</td></tr>
<tr><td>Resistance To Solder Heat Test</td><td>Appearance：No damage.</td><td>Depth: completely cover bottom the termination
<table><tr><th>Temperature(°C)</th><th>Time(s)</th><th>Temperature ramp/immersion and emersion rate</th><th>Number of heat cycles</th></tr><tr><td>260 ±5 (solder temp)</td><td>10 ±1</td><td>25mm/s ±6 mm/s</td><td>1</td></tr></table></td></tr>
<tr><td>Terminal Strength Test</td><td><table><tr><td>Series No.</td><td>2(Kg)</td></tr><tr><td>LAN</td><td>1.0(min.)</td></tr></table></td><td>With the component mounted on a PCB with the device to be tested, apply a force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.
  </td></tr>
</table>

9. Soldering and Mounting

9-1. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

9-1.1 Soldering Reflow:

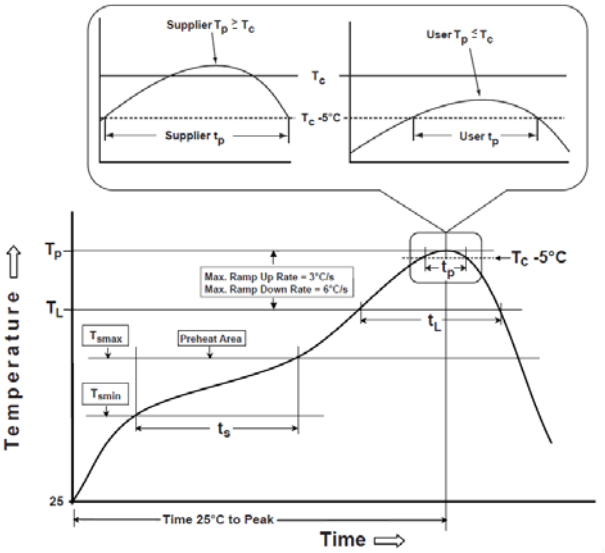
Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

9-1.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

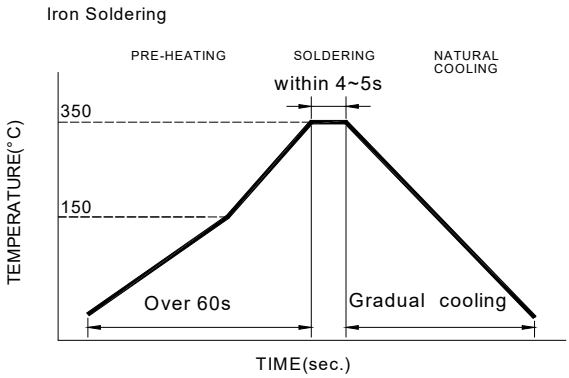
- Preheat circuit and products to 150℃
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 350℃ tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5 sec.

Fig.1 Soldering Reflow



Reflow times: 3 times max

Fig.2 Iron soldering temperature profiles



Iron Soldering times：1 times max

Table (1.1): Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min(T_{smin}) -Temperature Max(T_{smax}) -Time(t_s)from(T_{smin} to T_{smax})	 150℃ 200℃ 60-120seconds
Ramp-up rate($T_L$to T_p)	3℃/second max.
Liquidus temperature(T_L) Time(t_L)maintained above T_L	217℃ 60-150 seconds
Classification temperature(T_c)	See Table (1.2)
Time(t_p) at Tc- 5℃ (Tp should be equal to or less than Tc.)	< 30 seconds
Ramp-down rate(T_p to T_L)	6℃ /second max.
Time 25℃ to peak temperature	8 minutes max.

Tp: maximum peak package body temperature, **Tc**: the classification temperature.

For user (customer) **Tp** should be equal to or less than **Tc.**

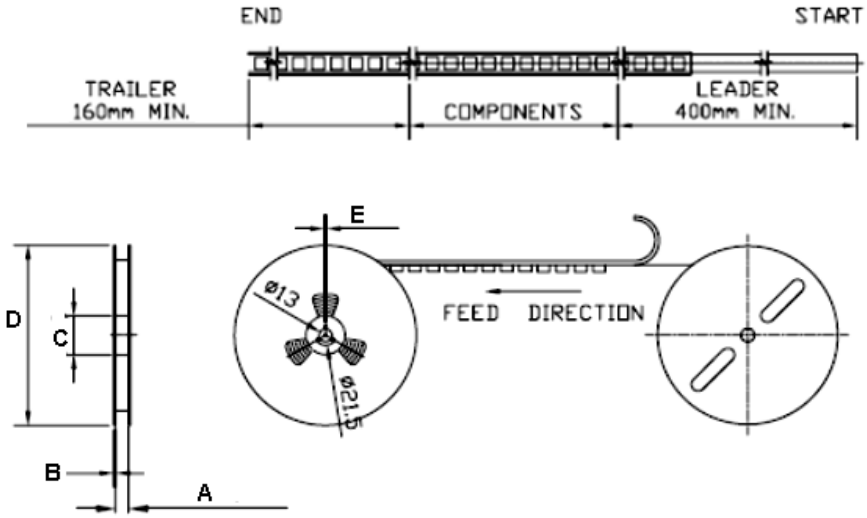
Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

	Package Thickness	Volume mm^3 <350	Volume mm^3 350-2000	Volume mm^3 >2000
PB-Free Assembly	<1.6mm	260℃	260℃	260℃
	1.6-2.5mm	260℃	250℃	245℃
	≥2.5mm	250℃	245℃	245℃

Reflow is referred to standard IPC/JEDEC J-STD-020E。

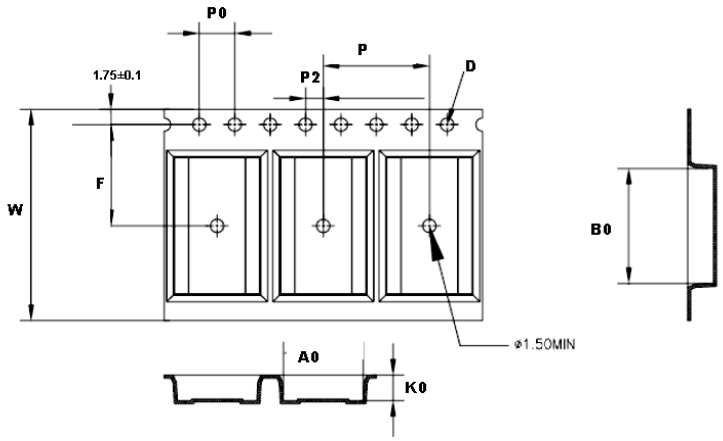
10. Packaging Information

(1) Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)
LAN-17J241P7D9	33.5±2.0	2.0±0.15	φ100	φ330±2	2.5

(2) Tape Dimension



Series	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	Po(mm)	P2(mm)	W(mm)	F(mm)	D(mm)
LAN-17J241P7D9	17.93±0.1	15.3±0.1	4.80±0.1	24.0±0.1	4.0±0.1	2.0±0.1	32±0.3	14.2±0.1	1.5±0.1

(3) Packaging Quantity

LAN	LAN-17J241P7D9
Chip / Reel	400

Application Notice

- Storage Conditions(component level)
  To maintain the solderability of terminal electrodes:
  1. TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
  2. Temperature and humidity conditions: Less than 40℃ and 60% RH.
  3. Recommended products should be used within 12 months form the time of delivery.
  4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
  1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
  2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
  3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

測試報告
Test Report

號碼(No.): ETR23300844　　日期(Date): 10-Mar-2023　　

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)
臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)
慶邦電子元器件 (泗洪) 有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)
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以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by the applicant as)：

樣品名稱(Sample Name)	:	AZ CHIP LAN TRANSFORMER
樣品型號(Style/Item No.)	:	LAN 、LAP SERIES
收件日(Sample Receiving Date)	:	03-Mar-2023
測試期間(Testing Period)	:	03-Mar-2023 to 10-Mar-2023

測試需求(Test Requested) : 依據客戶要求進行測試，測試項目請參閱測試結果表格。 (Testing item(s) is/are specified by client. Please refer to result table for testing item(s).)

測試結果(Test Results) : 請參閱下一頁 (Please refer to following pages.)

Troy Chang / Department Manager
Signed for and on behalf of
SGS TAIWAN LTD.
Chemical Laboratory - Taipei

PIN CODE: 791725F9

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測試部位敘述 (Test Part Description)

No.1 : 整體混測 (MIXED ALL PARTS)

測試結果 (Test Results)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鎘 (Cd) (Cadmium (Cd))	參考IEC 62321-5: 2013，以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鉛 (Pb) (Lead (Pb))	參考IEC 62321-5: 2013，以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
汞 (Hg) (Mercury (Hg))	參考IEC 62321-4: 2013+ AMD1: 2017，以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-4: 2013+ AMD1: 2017, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
六價鉻 Cr(VI) (Hexavalent Chromium Cr(VI))	參考IEC 62321-7-2: 2017，以紫外光-可見光分光光度計分析。(With reference to IEC 62321-7-2: 2017, analysis was performed by UV-VIS.)	mg/kg	8	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
一溴聯苯 (Monobromobiphenyl)	參考IEC 62321-6: 2015，以氣相層析儀/質譜儀分析。(With reference to IEC 62321-6: 2015, analysis was performed by GC/MS.)	mg/kg	5	n.d.
二溴聯苯 (Dibromobiphenyl)		mg/kg	5	n.d.
三溴聯苯 (Tribromobiphenyl)		mg/kg	5	n.d.
四溴聯苯 (Tetrabromobiphenyl)		mg/kg	5	n.d.
五溴聯苯 (Pentabromobiphenyl)		mg/kg	5	n.d.
六溴聯苯 (Hexabromobiphenyl)		mg/kg	5	n.d.
七溴聯苯 (Heptabromobiphenyl)		mg/kg	5	n.d.
八溴聯苯 (Octabromobiphenyl)		mg/kg	5	n.d.
九溴聯苯 (Nonabromobiphenyl)		mg/kg	5	n.d.
十溴聯苯 (Decabromobiphenyl)		mg/kg	5	n.d.
多溴聯苯總和 (Sum of PBBs)		mg/kg	-	n.d.
一溴聯苯醚 (Monobromodiphenyl ether)		mg/kg	5	n.d.
二溴聯苯醚 (Dibromodiphenyl ether)		mg/kg	5	n.d.
三溴聯苯醚 (Tribromodiphenyl ether)		mg/kg	5	n.d.
四溴聯苯醚 (Tetrabromodiphenyl ether)		mg/kg	5	n.d.
五溴聯苯醚 (Pentabromodiphenyl ether)		mg/kg	5	n.d.
六溴聯苯醚 (Hexabromodiphenyl ether)		mg/kg	5	n.d.
七溴聯苯醚 (Heptabromodiphenyl ether)		mg/kg	5	n.d.
八溴聯苯醚 (Octabromodiphenyl ether)		mg/kg	5	n.d.
九溴聯苯醚 (Nonabromodiphenyl ether)		mg/kg	5	n.d.
十溴聯苯醚 (Decabromodiphenyl ether)		mg/kg	5	n.d.
多溴聯苯醚總和 (Sum of PBDEs)		mg/kg	-	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鄰苯二甲酸丁苯甲酯 (BBP) (Butyl benzyl phthalate (BBP))	參考IEC 62321-8: 2017，以氣相層析儀/質譜儀分析。(With reference to IEC 62321-8: 2017, analysis was performed by GC/MS.)	mg/kg	50	n.d.
鄰苯二甲酸二丁酯 (DBP) (Dibutyl phthalate (DBP))		mg/kg	50	n.d.
鄰苯二甲酸二(2-乙基己基)酯 (DEHP) (Di-(2-ethylhexyl) phthalate (DEHP))		mg/kg	50	n.d.
鄰苯二甲酸二異丁酯 (DIBP) (Diisobutyl phthalate (DIBP))		mg/kg	50	n.d.
鄰苯二甲酸二異癸酯 (DIDP) (Diisodecyl phthalate (DIDP)) (CAS No.: 26761-40-0, 68515-49-1)		mg/kg	50	n.d.
鄰苯二甲酸二異壬酯 (DINP) (Diisononyl phthalate (DINP)) (CAS No.: 28553-12-0, 68515-48-0)		mg/kg	50	n.d.
鄰苯二甲酸二正辛酯 (DNOP) (Di-n-octyl phthalate (DNOP)) (CAS No.: 117-84-0)		mg/kg	50	n.d.
鄰苯二甲酸二正戊酯 (DNPP) (Di-n-pentyl phthalate (DNPP)) (CAS No.: 131-18-0)		mg/kg	50	n.d.
鄰苯二甲酸二正己酯 (DNHP) (Di-n-hexyl phthalate (DNHP)) (CAS No.: 84-75-3)		mg/kg	50	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
六溴環十二烷及所有主要被辨別出的異構物(HBCDD) (α- HBCDD, β- HBCDD, γ- HBCDD) (Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α- HBCDD, β- HBCDD, γ- HBCDD)) (CAS No.: 25637-99-4, 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	參考IEC 62321-9: 2021，以氣相層析儀/質譜儀分析。(With reference to IEC 62321-9: 2021, analysis was performed by GC/MS.)	mg/kg	20	n.d.
氟 (F) (Fluorine (F)) (CAS No.: 14762-94-8)	參考BS EN 14582: 2016，以離子層析儀分析。(With reference to BS EN 14582: 2016, analysis was performed by IC.)	mg/kg	50	271
氯 (Cl) (Chlorine (Cl)) (CAS No.: 22537-15-1)		mg/kg	50	96.4
溴 (Br) (Bromine (Br)) (CAS No.: 10097-32-2)		mg/kg	50	n.d.
碘 (I) (Iodine (I)) (CAS No.: 14362-44-8)		mg/kg	50	n.d.
全氟辛烷磺酸及其鹽類 (PFOS and its salts) (CAS No.: 1763-23-1 and its salts)	參考CEN/TS 15968: 2010，以液相層析串聯質譜儀分析。(With reference to CEN/TS 15968: 2010, analysis was performed by LC/MS/MS.)	mg/kg	0.01	n.d.
全氟辛酸及其鹽類 (PFOA and its salts) (CAS No.: 335-67-1 and its salts)		mg/kg	0.01	n.d.
銻 (Sb) (Antimony (Sb)) (CAS No.: 7440-36-0)	參考US EPA 3052: 1996，以感應耦合電漿發射光譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	n.d.

測試報告
Test Report

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備註(Note)：

1. mg/kg = ppm ; 0.1wt% = 0.1% = 1000ppm
2. MDL = Method Detection Limit (方法偵測極限值)
3. n.d. = Not Detected (未檢出) ; 小於MDL / Less than MDL
4. "-" = Not Regulated (無規格值)
5. 全氟辛烷磺酸及其鹽類包含等物質 (PFOS and its salts including) :
   CAS No.: 1763-23-1, 2795-39-3, 29457-72-5, 29081-56-9, 70225-14-8, 56773-42-3, 251099-16-8, 307-35-7, 91036-71-4, 4021-47-0 and others.
6. 全氟辛酸及其鹽類包含等物質 (PFOA and its salts including) :
   CAS No.: 335-67-1, 335-95-5, 2395-00-8, 335-93-3, 335-66-0, 3825-26-1 and others.
7. 樣品的測試是基於申請人要求混合測試，報告中的混合測試結果不代表其中個別單一材質的含量。
   The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

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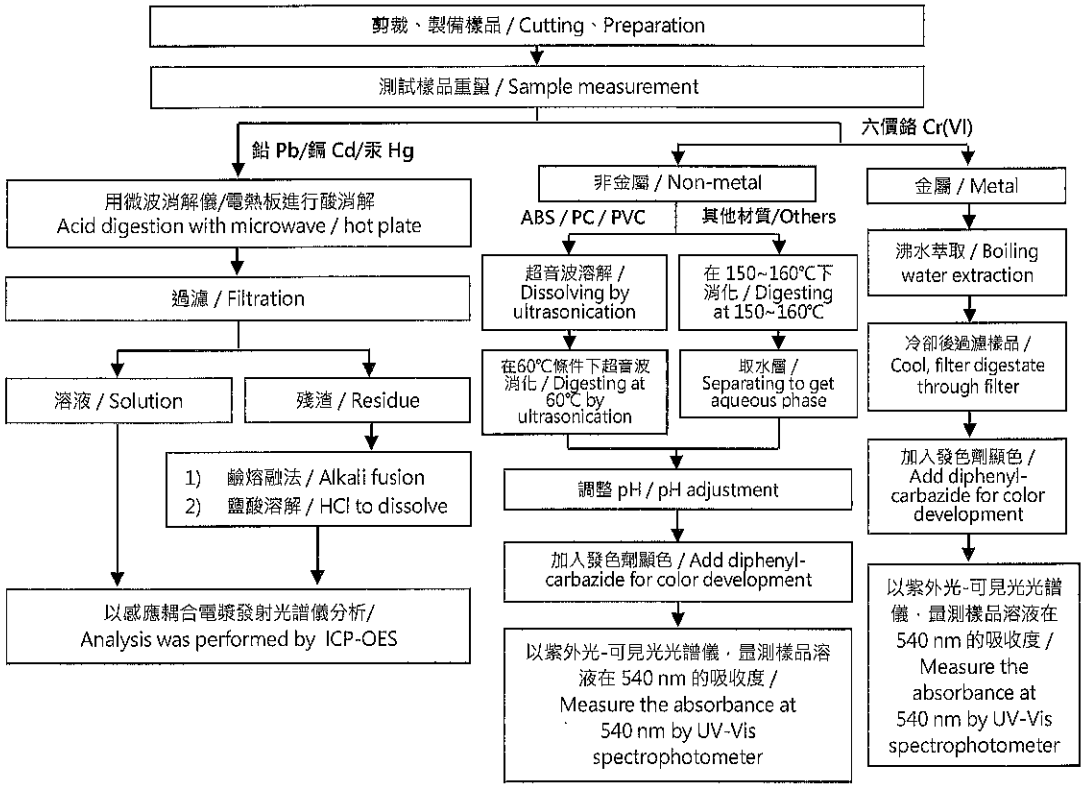
重金屬流程圖 / Analytical flow chart of heavy metal

根據以下的流程圖之條件，樣品已完全溶解。（六價鉻測試方法除外）
These samples were dissolved totally by pre-conditioning method according to below flow chart.
（Cr^{6+} test method excluded）



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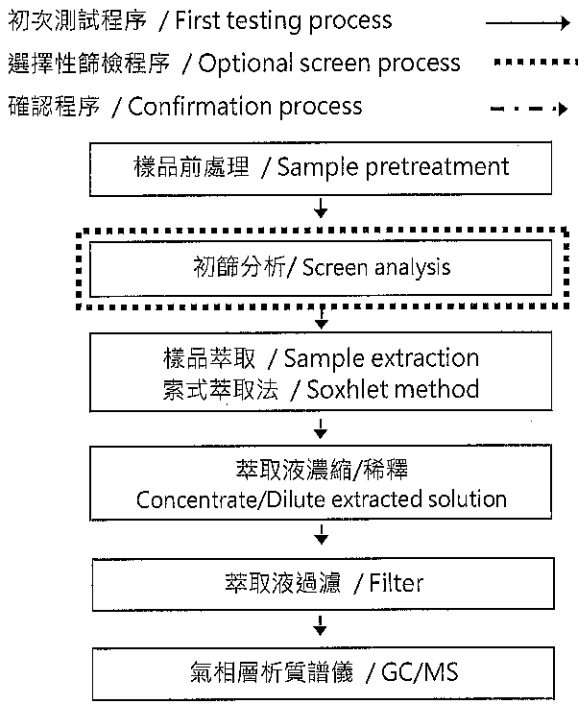
多溴聯苯/多溴聯苯醚分析流程圖 / Analytical flow chart - PBBs/PBDEs



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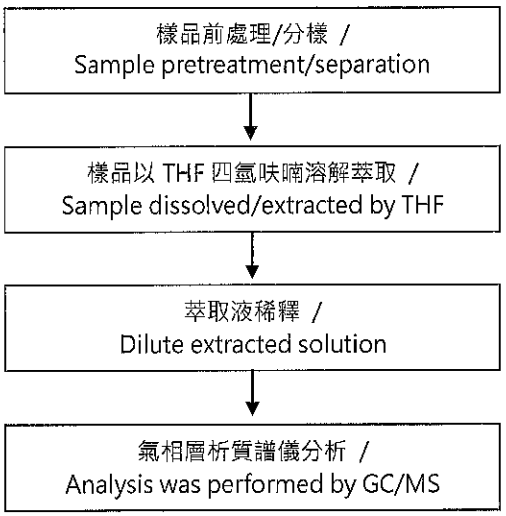
可塑劑分析流程圖 / Analytical flow chart - Phthalate

【測試方法/Test method: IEC 62321-8】



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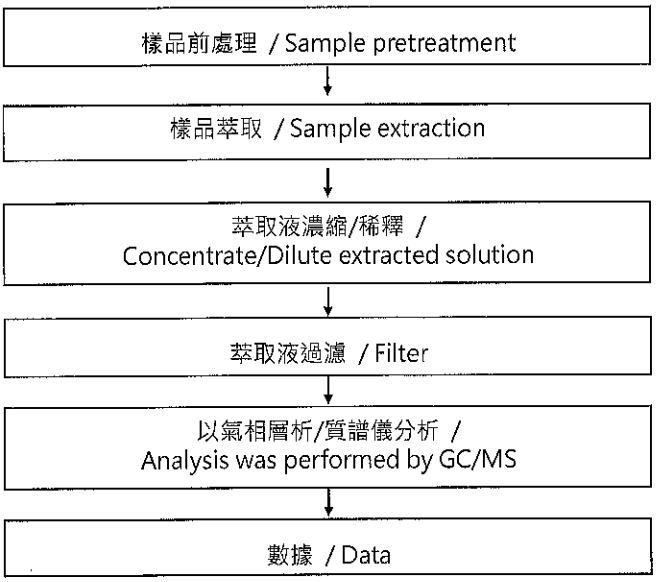
六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD



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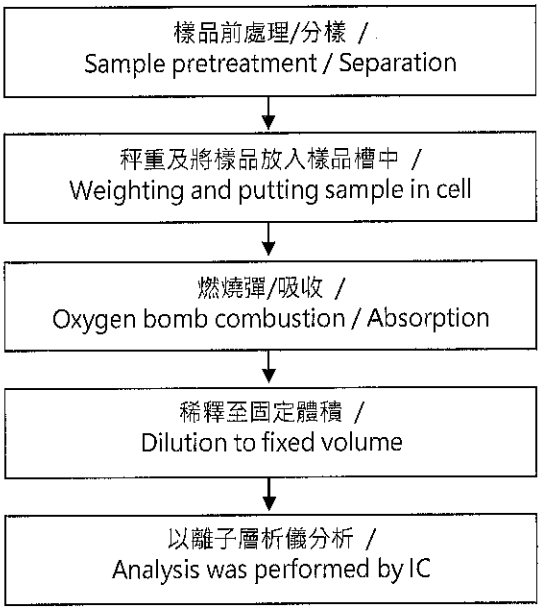
鹵素分析流程圖 / Analytical flow chart - Halogen



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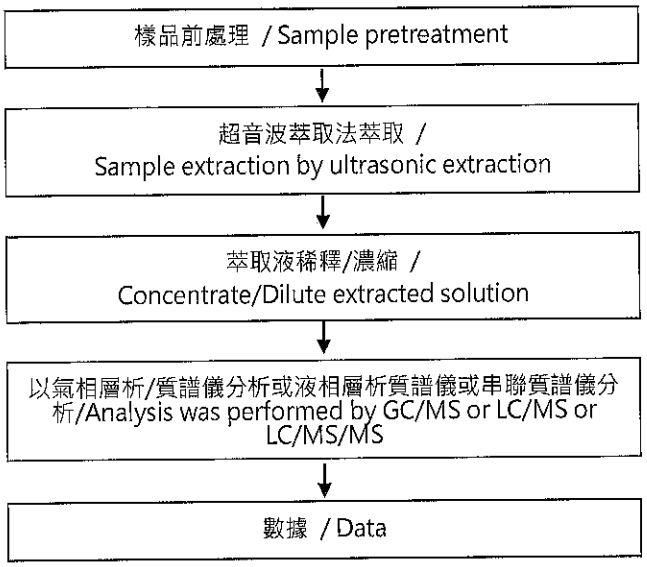
全氟化合物(包含全氟辛酸/全氟辛烷磺酸/其相關化合物等等)分析流程圖 / Analytical flow chart – PFAS (including PFOA/PFOS/its related compound, etc.)



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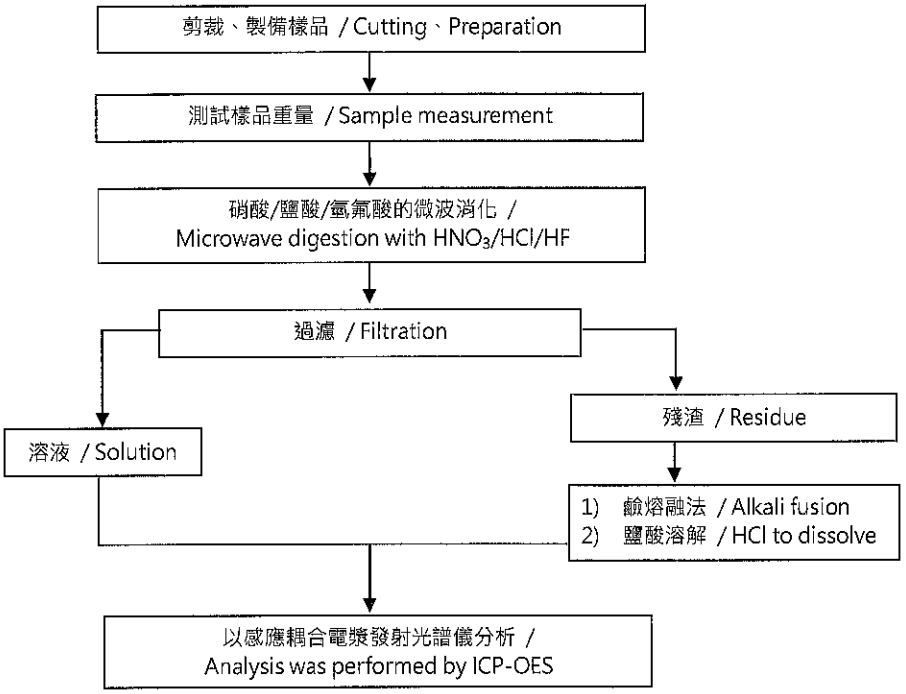
元素(含重金屬)分析流程圖 / Analytical flow chart of elements (Heavy metal included)

根據以下的流程圖之條件，樣品已完全溶解。

These samples were dissolved totally by pre-conditioning method according to below flow chart.

【參考方法/Reference method：US EPA 3051A、US EPA 3052】



* US EPA 3051A 方法未添加氫氟酸 / US EPA 3051A method does not add HF.

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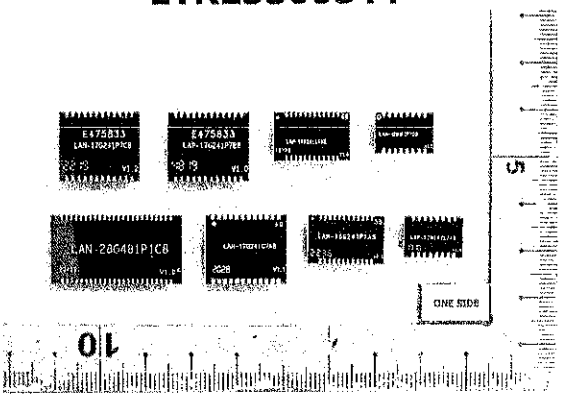
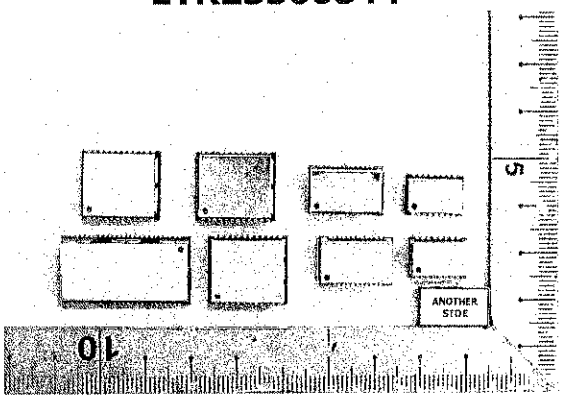
*** 照片中如有箭頭標示，則表示為實際檢測之樣品/部位. ***
(The tested sample / part is marked by an arrow if it's shown on the photo.)

ETR23300844



ETR23300844



** 報告結尾 (End of Report) **